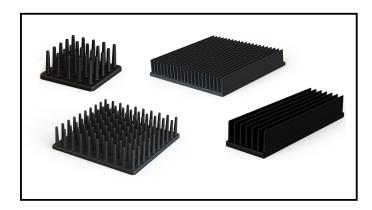


www.heatspreaders.com



Features:

- 30% lighter than regular aluminium heat sinks
- Reduced EMI issues

Applications:

Switching power supplies, AC motors, microprocessors and LED cooling.

Spreadfast thermally conductive engineering plastic has been developed for heat sink housing that requires high thermal conductivity. It has a 30% reduced weight when compared with similar performing aluminium material.

The material has excellent mouldability for injection moulding and a much higher production yield than aluminium die casting.

Four popular geometries have been designed for various applications. Special sizes and geometries are available.

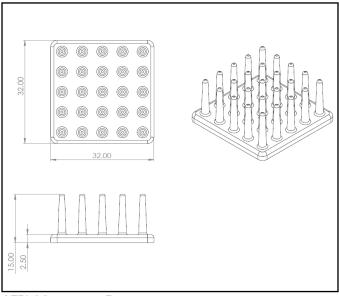
MPN	Title	Length mm	Width mm	Height mm
SFPLAS-6202-15P	Heatsink, plastic, 62x62x15mm, pin	65	65	20
SFPLAS-65x62-11L	Heatsink, plastic, 65x62x11mm, line	65	65	15
SFPLAS-65x20-11L	Heatsink, plastic, 65x20x11mm, line	65	25	15
SFPLAS-3002-15P	Heatsink, plastic, 30x30x15mm, pin	35	35	20

	Property	Units	Test	Value
Physical	Material	N/A	-	Nylon
	Colour	-	Visual	Black
	Melt index	g/10min	(ISO 1133)	4
	Specific gravity	g/cm3	ISO 1183	1.45
	Shrinkage	LFM	ISO 294	0.1
Mechanical	Tensile strength	MPa	ISO 527	55
	Flexural strength	MPa	ISO 178	80
	Flexural modulus	MPa	ISO 178	15800
	Impact strength, notched	kJ/m2	ISO 180	2.5-3.5
Thermal	Thermal conductivity (through thickness)	W/mK	ASTM E1461	5
	Thermal conductivity (in plane)	W/mK	ASTM E1461	15
	Heat deflection temp.	°C	ASTM D648	150
	Flame retardancy @ 1mm thick sample	-	UL 94	V-0
Electrical	Dielectric constant @1MHz	Е	ASTM D150	4.5
	Volume resistivity	Ωm	ASTM D257	10000

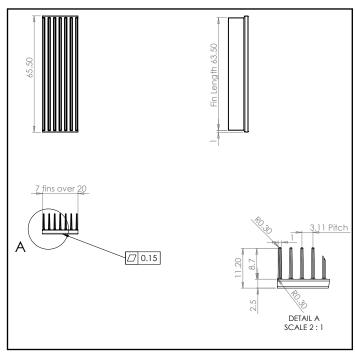


www.heatspreaders.com

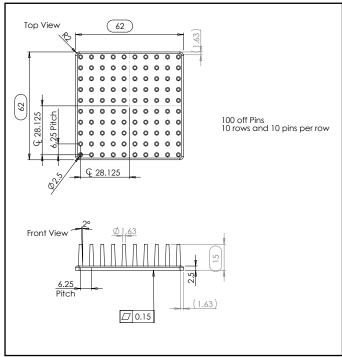
Drawings



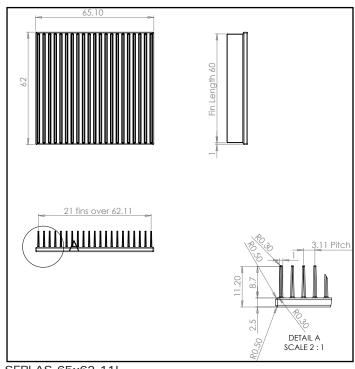
SFPLAS-3002-15P



SFPLAS-6020-9L



SFPLAS-6202-15P

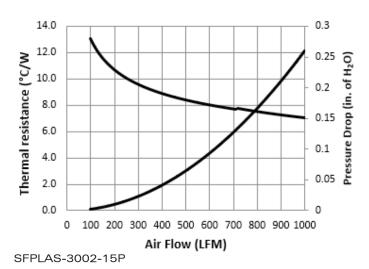


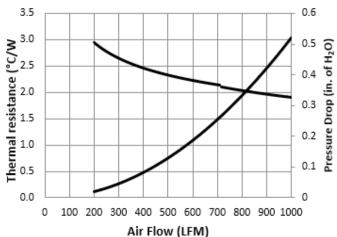
SFPLAS-65x62-11L



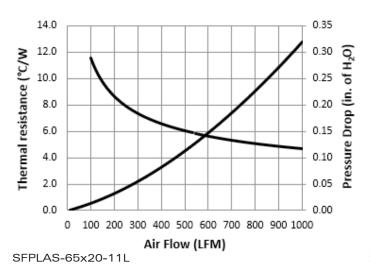
www.heatspreaders.com

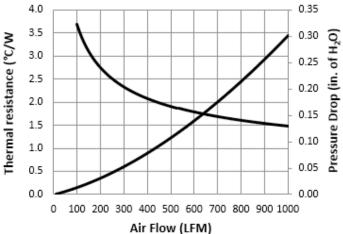
Graphs





SFPLAS-6202-15P





SFPLAS-65x62-11L